

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	ТҮР	UNIT
Junction-to-lead thermal resistance	R <sub>eJL</sub>	10	°C/W
Junction-to-ambient thermal resistance	R <sub>eja</sub>	47	°C/W

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_A = 25^{\circ}C$ unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage per diode <sup>(1)</sup>	$I_F = 2A, T_J = 25^{\circ}C$	V <sub>F</sub>	-	1.1	V
Reverse current @ rated $V_R$ per diode <sup>(2)</sup>	T <sub>J</sub> = 25°C	. I <sub>R</sub>	-	10	μA
	T <sub>J</sub> = 125°C		-	500	μA

#### Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION		
ORDERING CODE <sup>(1)(2)</sup>	PACKAGE	PACKING
D2SBx	GBL	25 / Tube
D2SBxH	GBL	25 / Tube

Notes:

1. "x" defines voltage from 50V(D2SB05) to 800V(D2SB80)

2. "H" means AEC-Q101 qualified



## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

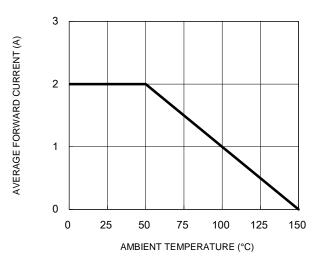
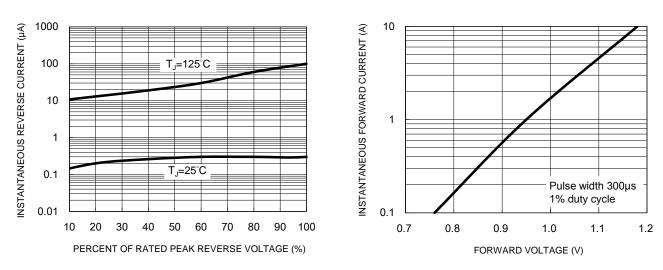


Fig.1 Forward Current Derating Curve

#### **Fig.3 Typical Reverse Characteristics**



240

180

120

60

0

0.1

f=1.0MHz Vsig=50mVp-p

1

CAPACITANCE (pF)

### Fig.5 Maximum Non-Repetitive Forward Surge Current

Fig.2 Typical Junction Capacitance

10

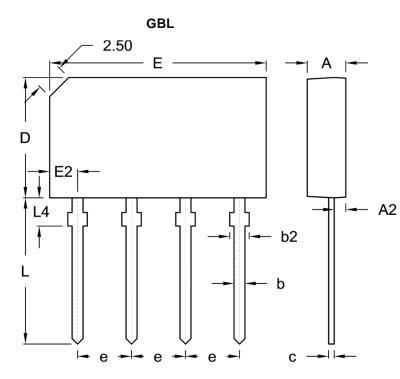
REVERSE VOLTAGE (V)

**Fig.4 Typical Forward Characteristics** 

100



PACKAGE OUTLINE DIMENSIONS



DIM.	Unit	Unit (mm)		(inch)
DIN.	Min.	Max.	Min.	Max.
А	3.30	3.70	0.130	0.146
A2	0.80	1.20	0.031	0.047
b	0.90	1.10	0.035	0.043
b2	1.30	2.00	0.051	0.079
с	0.40	0.60	0.016	0.024
D	10.70	11.30	0.421	0.445
E	19.70	20.30	0.776	0.799
E2	2.30	2.70	0.091	0.106
е	4.80	5.20	0.189	0.205
L	13.00	14.00	0.512	0.551
L4	2.30	2.70	0.091	0.106

#### **MARKING DIAGRAM**



P/N	= Marking Code
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G = Green Compound

YWW = Date Code

F = Factory Code



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